

International Rectifier **IRFK6H350, IRFK6J350**

Isolated Base Power HEX-pak™ Assembly - Parallel Chip Configuration

- High Current Capability.
- UL recognised E78996.
- Electrically Isolated Base Plate.
- Easy Assembly into Equipment.



Description

The HEX-pak™ utilises the well-proven HEXFET™ die, combining low on-state resistance with high transconductance. These superior technology die are assembled by state of the art techniques into the TO-240 package, featuring 2.5kV rms isolation and solid M5 screw connections. The small footprint means the package is highly suited to power applications where space is a premium. Available in two versions, IRFK.H... for fast switching and IRFK.J... for oscillation sensitive applications.

$$V_{DS} = 400V$$

$$R_{DS(on)} = 50m\Omega$$

$$I_D = 75A$$

Absolute Maximum Rating

	Parameter	Max.	Units
I_D @ $T_C=25^\circ C$	Continuous Drain Current	75	A
I_D @ $T_C=100^\circ C$	Continuous Drain Current	48	A
I_{DM}	Pulse Drain Current	300	A ①
P_D @ $T_C=25^\circ C$	Maximum Power Dissipation	625	W
V_{GS}	Gate-to-Source Voltage	20	V
V_{INS}	R.M.S. Isolation Voltage, circuit to base	2.5	kV
T_J	Operating Junction Temperature Range	-40 to 150	$^\circ C$
T_{STG}	Storage Temperature Range	-40 to 150	$^\circ C$

Thermal and Mechanical Specifications

	Parameter	Min.	Typ.	Max.	Units
R_{thJC}	Junction-to-Case	-	-	0.20	K/W ②
R_{thCS}	Case-to-Sink, smooth & greased surface	-	0.1	-	K/W
T	Mounting Torque +10%				③
	HEXpak to Heatsink	-	5	-	Nm
	Busbar to HEXpak	-	3	-	Nm
wt	Approximate Weight	-	140	-	g
		-	5	-	oz

Notes:

- ① - Repetitive Rating; Pulse width limited by maximum junction temperature see figure 8.
- ② - Per Module.
- ③ - A mounting compound is recommended and the torque should be rechecked after a period of three hours to allow for the spread of the compound.

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Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (Unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions	
B_{VDSS}	Drain-to-Source Breakdown voltage	400	-	-	V	$V_{GS}=0V, I_D=1.0mA$	
$R_{DS(on)}$	Static Drain-to-Source On-State Resistance	-	42	50	m Ω	$V_{GS}=10V, I_D=48A$	
$I_{D(on)}$	On-State Drain Current	75	-	-	A	$V_{DS} > I_{D(on)} \times R_{DS(on)max}, V_{GS}=10V$	
$V_{GS(th)}$	Gate Threshold Voltage	2.0	-	4.0	V	$V_{DS}=V_{GS}, I_D=1.5mA$	
g_{fs}	Forward Transconductance ④	48	75	-	S	$V_{DS} > 50V, I_D=48A$	
I_{DSS}	Zero Gate Voltage Drain Current	-	-	1.5	mA	$V_{DS}=V_{DSmax}, V_{GS}=0V$	
		-	-	6.0	mA	$V_{GS}=10V, T_C=125^\circ\text{C}, V_{DS}=V_{DSmax} \times 0.8$	
I_{GSS}	Gate-to-Source Leakage Forward	-	-	600	nA	$V_{GS}=20V$	
I_{GSS}	Gate-to-Source Leakage Reverse	-	-	-600	nA	$V_{GS}=-20V$	
Q_g	Total Gate Charge	-	660	820	nC	$I_D=75A, V_{GS}=10V,$	
Q_{gs}	Gate-to-Source Charge	-	100	125	nC	$V_{DS}=V_{DSmax} \times 0.8$	
Q_{gd}	Gate-to-Drain ("Miller") Charge	-	275	400	nC		
$t_{d(on)}$	Turn-on Delay Time	IRFK6H350	-	55	-	ns	$V_{DD}=180V, I_D=48A,$
		IRFK6J350	-	65	-	ns	
t_r	Rise Time	IRFK6H350	-	55	-	ns	$V_{GS}=10V,$
		IRFK6J350	-	70	-	ns	
$t_{d(off)}$	Turn-off Delay Time	IRFK6H350	-	300	-	ns	$R_{SOURCE}=3.3\Omega$
		IRFK6J350	-	400	-	ns	
t_f	Fall Time	IRFK6H350	-	70	-	ns	
		IRFK6J350	-	110	-	ns	
L_{DS}	Drain-to-Source Inductance	-	18	-	nH		
C_{ISS}	Input Capacitance	-	16.3	-	nF	$V_{GS}=0V, V_{DS}=25V,$	
C_{OSS}	Output Capacitance	-	3.8	-	nF	$f=1.0MHz$	
C_{RSS}	Reverse Transfer Capacitance	-	2.0	-	nF		
	Linear Degrating Factor	-	-	5	W/K		

Source-Drain Diode Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
I_S	Continuous Source Current (Body Diode)	-	-	75	A	
I_{SM}	Pulsed Source Current (Body Diode)	-	-	260	A	
V_{SD}	Diode Forward Voltage	-	-	1.6	V	$V_{GS}=0V, I_S=75A, T_C=25^\circ\text{C}$
t_{rr}	Reverse Recovery Time	180	400	880	ns	$di/dt=400A/\mu s, T_J=150^\circ\text{C}$
Q_{rr}	Reverse Recovered Charge	12.0	30.0	70.0	μC	$I_S=75A$

Notes:

④ - Pulse Width $\leq 300\mu s$; Duty cycle $\leq 2\%$.



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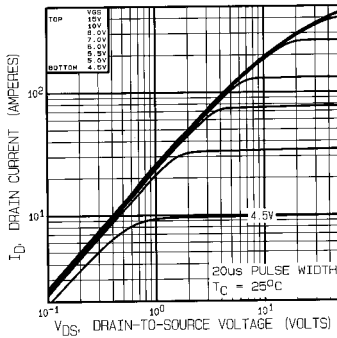


Fig 1. Typical Output Characteristics,
 $T_C=25^\circ\text{C}$

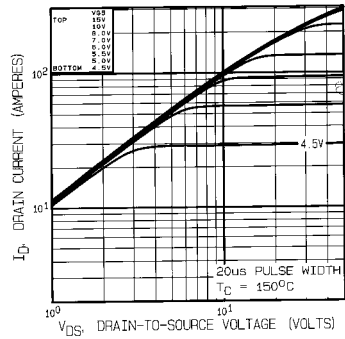


Fig 2. Typical Output Characteristics,
 $T_C=150^\circ\text{C}$

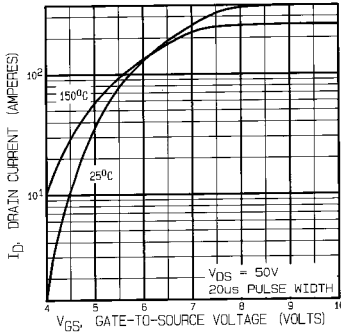


Fig 3. Typical Transfer Characteristics

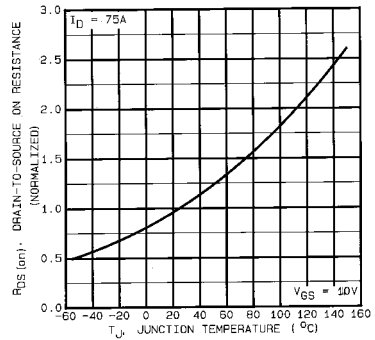


Fig 4. Normalized On-Resistance Vs.
Temperature

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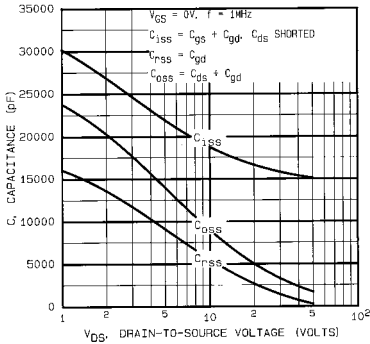


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

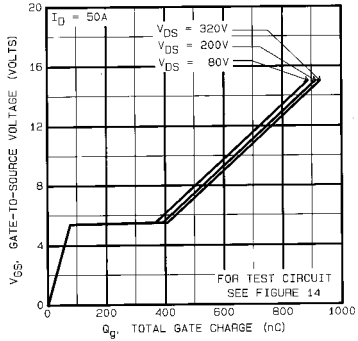


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

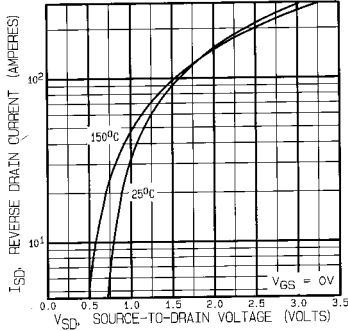


Fig 7. Typical Source-Drain Diode Forward Voltage

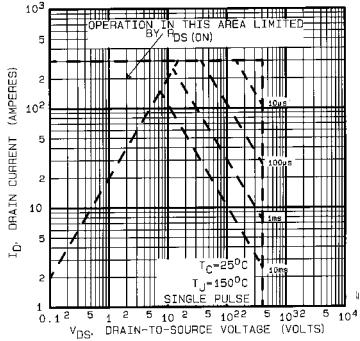


Fig 8. Maximum Safe Operating Area



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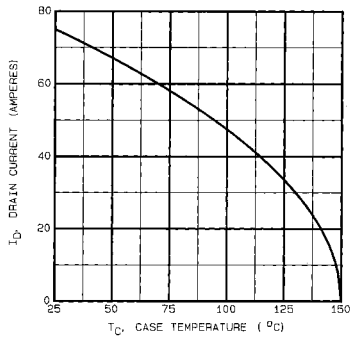


Fig 9. Maximum Drain Current Vs. Case Temperature

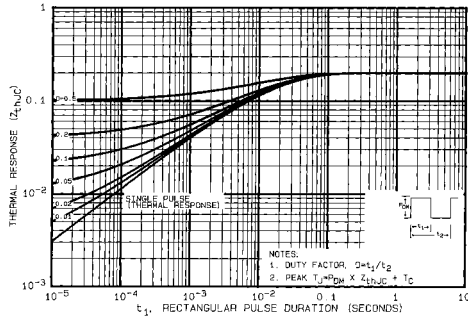


Fig 10. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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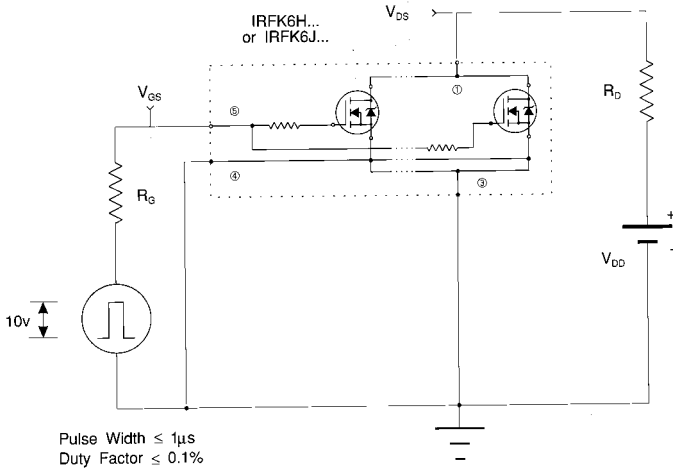


Fig 11a. Switching Time Test Circuit

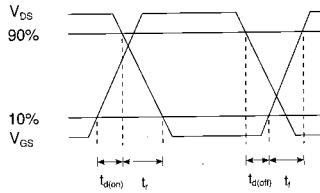
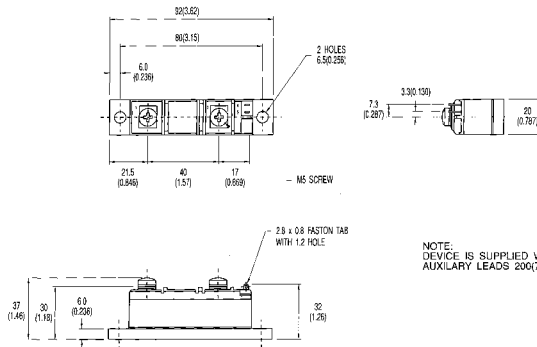
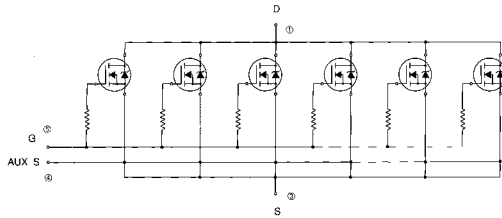


Fig 11b. Switching Time Waveforms

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Circuit Configuration and Outline



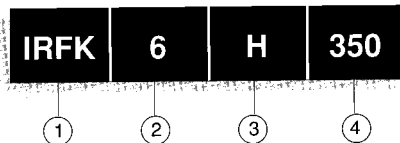
NOTE:
DEVICE IS SUPPLIED WITH
AUXILIARY LEADS 200(7.87) LONG

All dimensions in millimetres (inches)

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Part Numbering



1. - HEX-pak Module.
2. - Number of HEXFETs in parallel.
3. - H - Fast switching.
 - J - Oscillation resistant for sensitive applications.
4. - Voltage code:-
 - 054 - 60V
 - 150 - 100V
 - 250 - 200V
 - 350 - 400V
 - 450 - 500V
 - C50 - 600V

WORLD HEADQUARTERS: 233 Kansas St., EL SEGUNDO, California 90245, USA. Tel:(213) 772-2000. Tlx:664464. Fax:(213) 772-9028
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GERMANY: Saalburgstr. 157, D-6380 BAD HOMBURG. Tel:(61)72 37066. Tlx:410404. Fax:(61)72 37065.
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U.S.A.:
Central Zone: 2401 Plum Grove Road, Suite 111, PALATINE, IL 60067. Tel:(312)397-0062. Fax:(312)397-0114
Eastern Zone: 71 Grand Avenue, PALISADES PARK, NJ07650. Tel:(201)943-4554. Fax:(201)943-5754.
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